

X9251

Single Supply/Low Power/256-Tap/SPI Bus, Quad Digitally-Controlled (XDCP™) Potentiometer

FN8166 Rev 6.00 December 3, 2014

The X9251 integrates four digitally controlled potentiometers (XDCP) on a monolithic CMOS integrated circuit.

The digitally controlled potentiometers are implemented with a combination of resistor elements and CMOS switches. The position of the wipers are controlled by the user through the SPI bus interface. Each potentiometer has associated with it a volatile Wiper Counter Register (WCR) and four nonvolatile Data Registers that can be directly written to and read by the user. The content of the WCR controls the position of the wiper. At power-up, the device recalls the content of the default Data Registers of each DCP (DR00, DR10, DR20, and DR30) to the corresponding WCR.

The XDCP can be used as a three terminal potentiometer or as a two terminal variable resistor in a wide variety of applications including control, parameter adjustments, and signal processing.

# **Features**

- · Four potentiometers in one package
- 256 resistor taps-0.4% resolution
- SPI serial interface for write, read, and transfer operations of the potentiometer
- Wiper resistance: 100Ω typical at V<sub>CC</sub> = 5V
- · 4 Nonvolatile data registers for each potentiometer
- · Nonvolatile storage of multiple wiper positions
- Standby current <5µA max</li>
- V<sub>CC</sub>: 2.7V to 5.5V operation
- 50kΩ version of total resistance
- 100 year data retention
- · Single supply version of X9250
- Endurance: 100,000 data changes per bit per register
- 24 Ld SOIC, 24 Ld TSSOP
- · Low power CMOS
- · Pb-free (RoHS compliant)

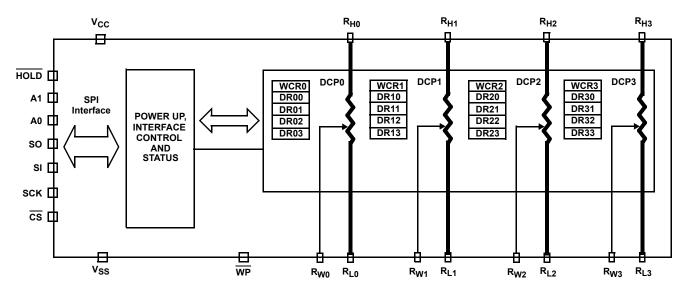


FIGURE 1. FUNCTIONAL DIAGRAM

# **Circuit Level Applications**

- · Vary the gain of a voltage amplifier
- Provide programmable DC reference voltages for comparators and detectors
- · Control the volume in audio circuits
- · Trim out the offset voltage error in a voltage amplifier circuit
- · Set the output voltage of a voltage regulator
- . Trim the resistance in Wheatstone bridge circuits
- Control the gain, characteristic frequency and Q-factor in filter circuits
- Set the scale factor and zero point in sensor signal conditioning circuits
- · Vary the frequency and duty cycle of timer ICs
- · Vary the DC biasing of a pin diode attenuator in RF circuits
- Provide a control variable (I, V, or R) in feedback circuits

# **System Level Applications**

- · Adjust the contrast in LCD displays
- Control the power level of LED transmitters in communication systems
- Set and regulate the DC biasing point in an RF power amplifier in wireless systems
- · Control the gain in audio and home entertainment systems
- · Provide the variable DC bias for tuners in RF wireless systems
- Set the operating points in temperature control systems
- · Control the operating point for sensors in industrial systems
- Trim offset and gain errors in artificial intelligent systems

# **Ordering Information**

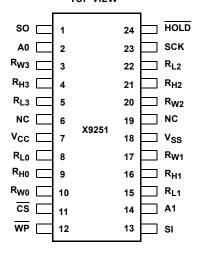
PART NUMBER (Notes 2, 3)	PART MARKING	V <sub>CC</sub> LIMITS (V)	POTENTIOMETER ORGANIZATION (kΩ)	TEMP RANGE (°C)	PACKAGE (Pb-Free)	PKG. DWG.#
X9251US24Z (Note 1)	X9251US Z	5 ±10%	50	0 to +70	24 Ld SOIC (300 mil)	M24.3
X9251US24IZ ( <u>Note 1</u> )	X9251US ZI			-40 to +85	24 Ld SOIC (300 mil)	M24.3
X9251UV24Z	X9251UV Z			0 to +70	24 Ld TSSOP (4.4mm)	M24.173
X9251UV24IZ	X9251UV ZI			-40 to +85	24 Ld TSSOP (4.4mm)	M24.173
X9251US24IZ-2.7 (Note 1)	X9251US ZG	2.7 to 5.5		-40 to +85	24 Ld SOIC (300 mil)	M24.3
X9251US24Z-2.7 (Note 1)	X9251US ZG			0 to +70	24 Ld SOIC (300 mil)	M24.3
X9251UV24Z-2.7	X9251UV ZF			0 to +70	24 Ld TSSOP (4.4mm)	M24.173
X9251UV24IZ-2.7 ( <u>Note 1</u> )	X9251UV ZG			-40 to +85	24 Ld TSSOP (4.4mm)	M24.173

#### NOTES:

- 1. Add "T1" suffix for tape and reel.
- 2. These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
- 3. For Moisture Sensitivity Level (MSL), please see product information page for X9251. For more information on MSL, please see tech brief TB363

# **Pin Configuration**

X9251 (24 LD SOIC/TSSOP) TOP VIEW



# **Pin Descriptions**

PIN (SOIC)	SYMBOL	FUNCTION
1	S0	Serial Data Output for SPI bus
2	A0	Device Address for SPI bus (see Note 4)
3	R <sub>W3</sub>	Wiper Terminal of DCP3
4	R <sub>H3</sub>	High Terminal of DCP3
5	R <sub>L3</sub>	Low Terminal of DCP3
7	v <sub>cc</sub>	System Supply Voltage
8	R <sub>LO</sub>	Low Terminal of DCP0
9	R <sub>HO</sub>	High Terminal of DCP0
10	R <sub>WO</sub>	Wiper Terminal of DCP0
11	CS	SPI bus. Chip Select active low input
12	WP	Hardware Write Protect - active low
13	SI	Serial Data Input for SPI bus
14	A1	Device Address for SPI bus (see Note 4)
15	R <sub>L1</sub>	Low Terminal of DCP1
16	R <sub>H1</sub>	High Terminal of DCP1
17	R <sub>W1</sub>	Wiper Terminal of DCP1
18	V <sub>SS</sub>	System Ground
20	R <sub>W2</sub>	Wiper Terminal of DCP2
21	R <sub>H2</sub>	High Terminal of DCP2
22	R <sub>L2</sub>	Low Terminal of DCP2
23	SCK	Serial Clock for SPI bus
24	HOLD	Device select. Pauses the SPI serial bus
6, 19	NC	No Connect

#### NOTE:

4. A0 and A1 device address pins must be tied to a logic level.

# **Functional Pin Descriptions**

#### **Bus Interface Pins**

#### **SERIAL OUTPUT (SO)**

SO is a serial data output pin. During a read cycle, data is shifted out on this pin. Data is clocked out by the falling edge of the serial clock.

#### **SERIAL INPUT (SI)**

SI is the serial data input pin. All opcodes, byte addresses and data to be written to the device registers are input on this pin. Data is latched by the rising edge of the serial clock.

#### **SERIAL CLOCK (SCK)**

The SCK input is used to clock data into and out of the X9251.

### **HOLD (HOLD)**

HOLD is used in conjunction with the  $\overline{\text{CS}}$  pin to select the device. Once the part is selected and a serial sequence is underway,  $\overline{\text{HOLD}}$  may be used to pause the serial communication with the controller without resetting the serial sequence. To pause,  $\overline{\text{HOLD}}$  must be brought LOW while SCK is LOW. To resume communication,  $\overline{\text{HOLD}}$  is brought HIGH, again while SCK is LOW. If the pause feature is not used,  $\overline{\text{HOLD}}$  should be held HIGH at all times.

#### **DEVICE ADDRESS (A1 AND A0)**

The address inputs are used to set the two least significant bits of the slave address. A match in the slave address serial data stream must be made with the address input in order to initiate communication with the X9251. Device pins A1 and A0 must be tied to a logic level which specifies the internal address of the device, see Figures 3, 4, 5, 6 and 7.

#### CHIP SELECT (CS)

When  $\overline{\text{CS}}$  is HIGH, the X9251 is deselected and the SO pin is at high impedance, and (unless an internal write cycle is underway) the device is in the standby state.  $\overline{\text{CS}}$  LOW enables the X9251, placing it in the active power mode. It should be noted that after a power-up, a HIGH to LOW transition on  $\overline{\text{CS}}$  is required prior to the start of any operation.

#### **Potentiometer Pins**

#### $R_H, R_L$

The R $_{H}$  and R $_{L}$  pins are equivalent to the terminal connections on a mechanical potentiometer. Since there are 4 potentiometers, there are 4 sets of R $_{H}$  and R $_{L}$  such that R $_{H0}$  and R $_{L0}$  are the terminals of DCPO and so on.

### R<sub>W</sub>

The wiper pins are equivalent to the wiper terminal of a mechanical potentiometer. Since there are 4 potentiometers, there are 4 sets of  $R_W$  such that  $R_{W0}$  is the terminals of DCP0 and so on.

### Supply Pins

# SYSTEM SUPPLY VOLTAGE ( $V_{CC}$ ) AND SUPPLY GROUND ( $V_{SS}$ )

The  $V_{CC}$  pin is the system supply voltage. The  $V_{SS}$  pin is the system ground.

## **Other Pins**

#### **NO CONNECT**

No connect pins should be left floating. These pins are used for Intersil manufacturing and testing purposes.

#### HARDWARE WRITE PROTECT INPUT (WP)

The  $\overline{\text{WP}}$  pin, when LOW, prevents nonvolatile writes to the Data Registers.

# **Principles of Operation**

The X9251 is an integrated circuit incorporating four DCPs and their associated registers and counters, and a serial interface providing direct communication between a host and the potentiometers.

### **DCP Description**

Each DCP is implemented with a combination of resistor elements and CMOS switches. The physical ends of each DCP are equivalent to the fixed terminals of a mechanical potentiometer ( $R_H$  and  $R_L$  pins). The RW pin is an intermediate node, equivalent to the wiper terminal of a mechanical potentiometer.

The position of the wiper terminal within the DCP is controlled by an 8-bit volatile Wiper Counter Register (WCR).



#### **One of Four Potentiometers**

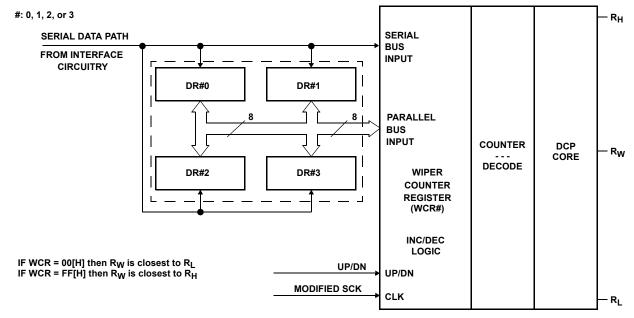


FIGURE 2. DETAILED POTENTIOMETER BLOCK DIAGRAM

### **Power-Up and Down Recommendations**

There are no restrictions on the power-up or power-down conditions of  $V_{CC}$  and the voltages applied to the potentiometer pins provided that  $V_{CC}$  is always more positive than or equal to  $V_H,\,V_L,\,$  and  $V_W$  (i.e.,  $V_{CC} \geq V_H,\,V_L,\,V_W$ ). The  $V_{CC}$  ramp rate specification is always in effect.

#### **Wiper Counter Register (WCR)**

The X9251 contains four Wiper Counter Registers, one for each potentiometer. The Wiper Counter Register can be envisioned as a 8-bit parallel and serial load counter with its outputs decoded to select one of 256 wiper positions along its resistor array. The contents of the WCR can be altered in four ways: it may be written directly by the host via the Write Wiper Counter Register instruction (serial load); it may be written indirectly by transferring the contents of one of four associated data registers via the XFR Data Register instruction (parallel load); it can be modified one step at a time by the Increment/Decrement instruction (see "Instruction Format" on page 10 for more details). Finally, it is loaded with the contents of its Data Register zero (DR#0) upon power-up (see Figure 2).

The wiper counter register is a volatile register; that is, its contents are lost when the X9251 is powered down. Although the register is automatically loaded with the value in DR#0 upon power-up, this may be different from the value present at

power-down. Power-up guidelines are recommended to ensure proper loadings of the DR#0 value into the WCR#.

### **Data Registers (DR)**

Each of the four DCPs has four 8-bit nonvolatile Data Registers. These can be read or written directly by the host. Data can also be transferred between any of the four Data Registers and the associated Wiper Counter Register. All operations changing data in one of the Data Registers is a nonvolatile operation and takes a maximum of 10ms.

If the application does not require storage of multiple settings for the potentiometer, the Data Registers can be used as regular memory locations for system parameters or user preference data.

Bits [7:0] are used to store one of the 256 wiper positions or data  $(0 \sim 255)$ .

#### **Status Register (SR)**

This 1-bit Status Register is used to store the system status.

WIP: Write In Progress status bit, read only.

- WIP = 1, indicates that high-voltage write cycle is in progress.
- WIP = 0, indicates that no high-voltage write cycle is in progress.

TABLE 1. WIPER COUNTER REGISTER, WCR (8-BIT), WCR[7:0]: USED TO STORE THE CURRENT WIPER POSITION (VOLATILE)

WCR7	WCR6	WCR5	WCR4	WCR3	WCR2	WCR1	WCRO
(MSB)							(LSB)

TABLE 2. DATA REGISTER, DR (8-BIT), DR[7:0]: USED TO STORE WIPER POSITIONS OR DATA (NONVOLATILE)

BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT O
(MSB)							(LSB)

# **Serial Interface**

The X9251 supports the SPI interface hardware conventions. The device is accessed via the SI input with data clocked in, on the rising SCK.  $\overline{\text{CS}}$  must be LOW and the  $\overline{\text{HOLD}}$  and  $\overline{\text{WP}}$  pins must be HIGH during the entire operation.

The SO and SI pins can be connected together, since they have three-state outputs. This can help to reduce system pin count.

## **Identification Byte**

The first byte sent to the X9251 from the host, following a  $\overline{\text{CS}}$  going HIGH to LOW, is called the Identification Byte. The most significant four bits of the Identification Byte are a Device Type Identifier, ID[3:0]. For the X9251, this is fixed as 0101 (refer to Table 3).

The least significant four bits of the Identification Byte are the Slave Address bits, AD[3:0]. For the X9251, A3 is 0, A2 is 0, A1 is the logic value at the input pin A1, and A0 is the logic value at the input pin A0. Only the device which Slave Address matches the incoming bits sent by the master executes the instruction. The A1 and A0 inputs can be actively driven by CMOS input signals or tied to  $V_{CC}$  or  $V_{SS}$ .

### **Instruction Byte**

The next byte sent to the X9251 contains the instruction and register pointer information. The four most significant bits are used to provide the instruction opcode (I[3:0]). The RB and RA bits point to one of the four Data Registers of each associated XDCP. The least two significant bits point to one of four Wiper Counter Registers or DCPs. The format is shown below in Table 4.

**TABLE 3. IDENTIFICATION BYTE FORMAT** 

	DEVICE TYPE	E IDENTIFIER			SLAVE	ADDRESS	
ID3	ID2	ID1	ID0	А3	A2	A1	AO
0	1	0	1	0	0	Pin A1 Logic Value	Pin A0 Logic Value
(MSB)							(LSB)

**TABLE 4. INSTRUCTION BYTE FORMAT** 

	INSTRUCTIO	ON OPCODE		REGISTER	SELECTION	DCP SELECTION (WCR SELECTION)					
13	12	11	10	RB	RA	P1	PO				
(MSB)	MSB)						(LSB)				

### **Data Register Selection**

REGISTER	RB	RA
DR#0	0	0
DR#1	0	1
DR#2	1	0
DR#3	1	1

#: 0, 1, 2, or 3

#### **TABLE 5. INSTRUCTION SET**

			ı	INSTRU	ICTION	SET			
INSTRUCTION	13	12	11	10	RB	RA	P1	P0	OPERATION
Read Wiper Counter Register	1	0	0	1	0	0	1/0	1/0	Read the contents of the Wiper Counter Register pointed to by P1, P0
Write Wiper Counter Register	1	0	1	0	0	0	1/0	1/0	Write new value to the Wiper Counter Register pointed to by P1, P0
Read Data Register	1	0	1	1	1/0	1/0	1/0	1/0	Read the contents of the Data Register pointed to by P1, P0 and RB, RA
Write Data Register	1	1	0	0	1/0	1/0	1/0	1/0	Write new value to the Data Register pointed to by P1, P0 and RB, RA
XFR Data Register to Wiper Counter Register	1	1	0	1	1/0	1/0	1/0	1/0	Transfer the contents of the Data Register pointed to by P1, P0 and RB, RA to its associated Wiper Counter Register



**TABLE 5. INSTRUCTION SET (Continued)** 

			ı	INSTRU	CTION	SET			
INSTRUCTION	13	12	11	10	RB	RA	P1	PO	OPERATION
XFR Wiper Counter Register to Data Register	1	1	1	0	1/0	1/0	1/0	1/0	Transfer the contents of the Wiper Counter Register pointed to by P1, P0 to the Data Register pointed to by RB, RA
Global XFR Data Registers to Wiper Counter Registers	0	0	0	1	1/0	1/0	0	0	Transfer the contents of the Data Registers pointed to by RB, RA of all four pots to their respective Wiper Counter Registers
Global XFR Wiper Counter Registers to Data Register	1	0	0	0	1/0	1/0	0	0	Transfer the contents of both Wiper Counter Registers to their respective data Registers pointed to by RB, RA of all four pots
Increment/Decrement Wiper Counter Register	0	0	1	0	0	0	1/0	1/0	Enable Increment/decrement of the Control Latch pointed to by P1, P0

NOTE: 1/0 = data is one or zero

#### Instructions

Four of the nine instructions are three bytes in length. These instructions are:

- Read Wiper Counter Register read the current wiper position of the selected potentiometer
- Write Wiper Counter Register change current wiper position of the selected potentiometer
- Read Data Register read the contents of the selected Data Register
- Write Data Register write a new value to the selected Data Register
- Read Status this command returns the contents of the WIP bit which indicates if the internal write cycle is in progress

The basic sequence of the three-byte instructions is illustrated in Figure 4. These three-byte instructions exchange data between the WCR and one of the Data Registers. A transfer from a Data Register to a WCR is essentially a write to a static RAM, with the static RAM controlling the wiper position. The response of the wiper to this action is delayed by  $t_{WRL}$ . A transfer from the WCR (current wiper position), to a Data Register is a write to nonvolatile memory and takes a minimum of  $t_{WR}$  to complete. The transfer can occur between one of the four potentiometer's WCR, and one of its associated registers, DRs; or it may occur globally, where the transfer occurs between all potentiometers and one associated register. The Read Status Register instruction is the only unique format (see Figure 6).

Four instructions require a two-byte sequence to complete. These instructions transfer data between the host and the X9251; either between the host and one of the data registers or directly

between the host and the Wiper Counter Register. These instructions are:

- XFR Data Register to Wiper Counter Register This transfers the contents of one specified Data Register to the associated Wiper Counter Register.
- XFR Wiper Counter Register to Data Register This transfers the contents of the specified Wiper Counter Register to the specified associated Data Register.
- Global XFR Data Register to Wiper Counter
   Register This transfers the contents of all specified Data
   Registers to the associated Wiper Counter Registers.
- Global XFR Wiper Counter Register to Data Register – This transfers the contents of all Wiper Counter Registers to the specified associated Data Registers.

# **Increment/Decrement Command**

The final command is Increment/Decrement (see Figures 7 and 8). The Increment/Decrement command is different from the other commands. Once the command is issued and the X9251 has responded with an Acknowledge, the master can clock the selected wiper up and/or down in one segment steps, thereby providing a fine tuning capability to the host. For each SCK clock pulse ( $t_{HIGH}$ ) while SI is HIGH, the selected wiper moves one wiper position towards the  $R_H$  terminal. Similarly, for each SCK clock pulse while SI is LOW, the selected wiper moves one wiper position towards the  $R_L$  terminal. A detailed illustration of the sequence and timing for this operation are shown. See "Instruction Format" on page 10 for more details.

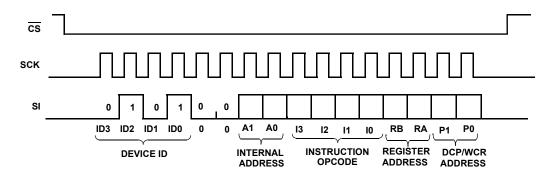


FIGURE 3. TWO-BYTE INSTRUCTION SEQUENCE

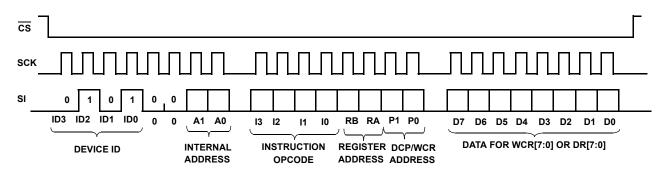


FIGURE 4. THREE-BYTE INSTRUCTION SEQUENCE SPI INTERFACE; WRITE CASE

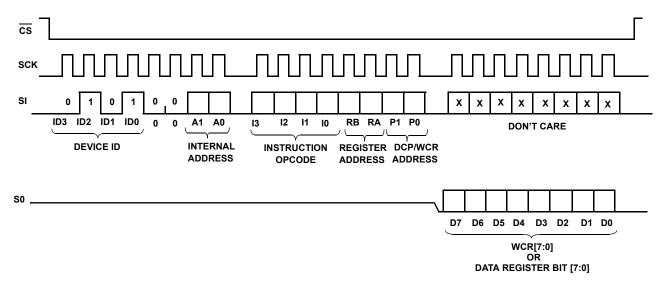


FIGURE 5. THREE-BYTE INSTRUCTION SEQUENCE SPI INTERFACE, READ CASE

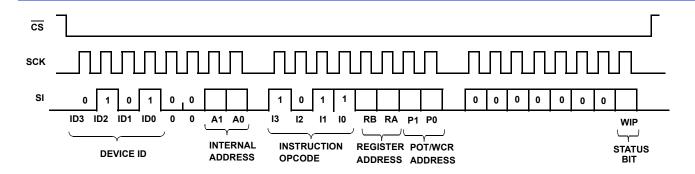


FIGURE 6. THREE-BYTE INSTRUCTION SEQUENCE (READ STATUS REGISTER)

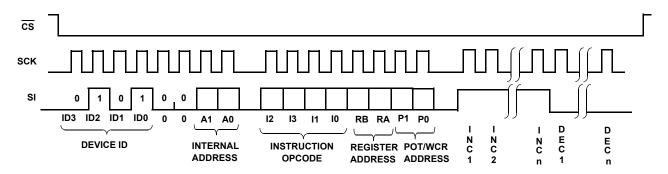


FIGURE 7. INCREMENT/DECREMENT INSTRUCTION SEQUENCE

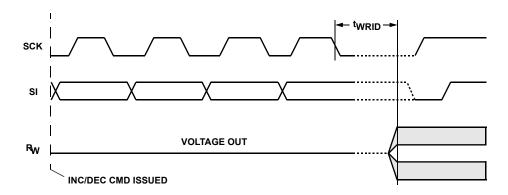


FIGURE 8. INCREMENT/DECREMENT TIMING SPEC

# **Instruction Format**

# **Read Wiper Counter Register (WCR)**

CS FALLING	_	EVICI DENT		_	,		VICE RESSI	ES	INSTRUCTION OPCODE				A		CR ESSE	s				ER F					CS RISING
EDGE	0 1 0 1			1	0 0 A1 A0				1 0 0 1			0 0 0 0			0	W C	o M	EDGE							
																	R 7	R 6	R 5	R 4	R 3	R 2	R 1	R 0	

# **Write Wiper Counter Register (WCR)**

CS FALLING			E TYF		,		VICE RESSI	INSTRUCTION OPCODE				А		CR ESSE	S		(SI			BYT IOST		SI)		CS RISING	
EDGE	0	1	0	1	0	0	A1	AO	1	0	1	0	0	0	0	0	W C R 7	W C R 6	W C R 5	W C R 4	W C R 3	W C R 2	W C R	W C R O	EDGE

## **Read Data Register (DR)**

CS FALLING	DEVICE TYPE DEVICE ADDRESSES							INSTRUCTION OPCODE				_	OR AN ADDR		-		(SEI	_		BYT 9271	_	SO)		CS RISING	
EDGE	0	1	0	1	0	0	A1	AO	1	0	1	1	RB	RA	P1	P0	D 7	D 6	D 5	D 4	D 3	D 2	D 1	D 0	EDGE

# **Write Data Register (DR)**

CS FALLING		EVIC DEN			,		EVICE RESS			STRI OPC			_	DR AN ADDR		-		(SI	D ENT I	ATA BY H		_	SI)		CS RISING	HIGH-VOLTAGE WRITE CYCLE	
EDGE	0	1	0	1	0	0	A1	AO	1	1	0	0	RB	RA	P1	PO	D 7	D 6	D 5	D 4	D 3	D 2	D 1	D 0	EDGE		

# **Global Transfer Data Register (DR) to Wiper Counter Register (WCR)**

CS FALLING EDGE	l		E TYPE CIFIER	_			EVICE RESSES		I		JCTIOI ODE	N	,	DR Addres	SES		CS RISING EDGE
	0	1	0	1	0	0	A1	A0	0	0	0	1	RB	RA	0	0	

# **Global Transfer Wiper Counter Register (WCR) to Data Register (DR)**

CS FALLING	_	EVICI DENT		_			EVICE RESSI	ES	IN	STRI OPC		ON	Al	DR DDRES	SSES		CS RISING	HIGH-VOLTAGE WRITE CYCLE
EDGE	0	1	0	1	0	0	A1	A0	1	0	0	0	RB	RA	0	0	EDGE	

# **Transfer Wiper Counter Register (WCR) to Data Register (DR)**

CS FALLING	_	EVICI DEN		_	,		EVICE RESSI	:s	IN	STRI OPC			_	R AND			CS RISING	HIGH-VOLTAGE WRITE CYCLE
EDGE	0	1	0	1	0	0	A1	AO	1	1	1	0	RB	RA	0	0	EDGE	

# **Transfer Data Register (DR) to Wiper Counter Register (WCR)**

CS FALLING EDGE	I	DEVICI IDEN	E TYPE TIFIER	_		_	EVICE PRESSE	S	II	NSTRI OPC	UCTIO ODE	N		DR AND ADDRES			CS RISING EDGE
	0	1	0	1	0	0	A1	AO	1	1	0	1	RB	RA	0	0	

# **Increment/Decrement Wiper Counter Register (WCR)**

CS FALLING			E TYI TIFIE	_	A		VICE RESSI	ES		STRU OPC			ΑI	W DDR		ES		INCR (SEN	,				CS RISING
EDGE	0	1	0	1	0	0	A1	AO	0	0	1	0	Χ	Χ	0	0	I/D	I/D			I/D	I/D	EDGE

## **Read Status Register (SR)**

CS FALLIN			E TYI TIFIE	_	,		EVICE RESS			STRI OPC			ΑĽ	W DDR		ES		(S	ENT		TA B' X92!		N SC	<b>)</b> )	CS RISING
G EDGE	0	1	0	1	0	0	<b>A1</b>	AO	0	1	0	1	0	0	0	1	0	0	0	0	0	0	0	WIP	EDGE

#### NOTES:

- 5. "A1 ~ A0": stands for the device addresses sent by the master.
- 6. WPx refers to wiper position data in the Counter Register
- 7. "I": stands for the increment operation, SI held HIGH during active SCK phase (high).
- 8. "D": stands for the decrement operation, SI held LOW during active SCK phase (high).



## **Absolute Maximum Ratings**

### 

# **Recommended Operating Conditions**

Commercial Temperature Range	0°C to +70°C
Industrial Temperature Range	40°C to +85°C
Supply Voltage (V <sub>CC</sub> ) Limits (Note 12)	
X9251	5V ±10%
X9251-2.7	2.7V to 5.5V
Pb-Free Reflow Profile	see <u>TB493</u>

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

### Analog Characteristics Over the recommended operating conditions unless otherwise specified.

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
R <sub>TOTAL</sub>	End to End Resistance	U version		50		kΩ
	End to End Resistance Tolerance				±20	%
R <sub>W</sub>	Wiper Resistance	$I_{W} = \frac{V(V_{CC})}{R_{TOTAL}} \text{ at } V_{CC} = 3V$			300	Ω
		$I_{W} = \frac{V(V_{CC})}{R_{TOTAL}} \text{ at } V_{CC} = 5V$			220	Ω
V <sub>TERM</sub>	Voltage on any R <sub>H</sub> or R <sub>L</sub> Pin	V <sub>SS</sub> = 0V	V <sub>SS</sub>		V <sub>CC</sub>	V
	Noise (Note 14)	Ref: 1V		-120		dBV/√Hz
	Resolution			0.4		%
	Absolute Linearity (Note 9)	$R_{w(n)(actual)} - R_{w(n)(expected)} $ (Note 13)	-1		+1	MI ( <u>Note 11</u> )
	Relative Linearity (Note 10)	$R_{W(n+1)} - [R_{W(n)+MI}] $ (Note 13)	-0.6		+0.6	MI ( <u>Note 11</u> )
	Temperature Coefficient of R <sub>TOTAL</sub>	( <u>Note 14</u> )		±300		ppm/°C
	Ratiometric Temp. Coefficient	( <u>Note 14</u> )		±20		ppm/°C
C <sub>H</sub> /C <sub>L</sub> /C <sub>W</sub>	Potentiometer Capacitances	See macromodel on page 13, (Note 14)		10/10/25		pF

# **DC Operating Characteristics** Over the recommended operating conditions unless otherwise specified.

SYMBOL	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
l <sub>CC1</sub>	V <sub>CC</sub> Supply Current (Active)	f <sub>SCK</sub> = 2.5MHz, SO = Open, V <sub>CC</sub> = 6V Other Inputs = V <sub>SS</sub>			400	μА
I <sub>CC2</sub>	V <sub>CC</sub> Supply Current (Nonvolatile Write)	f <sub>SCK</sub> = 2.5MHz, SO = Open, V <sub>CC</sub> = 6V Other Inputs = V <sub>SS</sub>		1	5	mA
I <sub>SB</sub>	V <sub>CC</sub> Current (Standby)	$\frac{\text{SCK} = \text{SI} = \text{V}_{\text{SS}}, \text{Addr.} = \text{V}_{\text{SS}},}{\text{CS}} = \text{V}_{\text{CC}} = 6\text{V}$			3	μА
ILI	Input Leakage Current	$V_{IN} = V_{SS}$ to $V_{CC}$			10	μΑ
I <sub>LO</sub>	Output Leakage Current	V <sub>OUT</sub> = V <sub>SS</sub> to V <sub>CC</sub>			10	μΑ
$v_{IH}$	Input HIGH Voltage		V <sub>CC</sub> x 0.7			V
$v_{IL}$	Input LOW Voltage				V <sub>CC</sub> x 0.3	V
$V_{OL}$	Output LOW Voltage	I <sub>OL</sub> = 3mA			0.4	V
V <sub>OH</sub>	Output HIGH Voltage	I <sub>OH</sub> = -1mA, V <sub>CC</sub> ≥ +3V	V <sub>CC</sub> - 0.8			V
V <sub>OH</sub>	Output HIGH Voltage	I <sub>OH</sub> = -0.4mA, V <sub>CC</sub> ≤ +3V	V <sub>CC</sub> - 0.4			V



#### **Endurance and Data Retention**

PARAMETER	MIN	UNITS
Minimum endurance	100,000	Data changes per bit per register
Data retention	100	years

## **Capacitance**

SYMBOL	TEST	TEST CONDITIONS	TYP	UNITS
C <sub>IN/OUT</sub> (Note 14)	Input/Output capacitance (SI)	V <sub>OUT</sub> = 0V	8	pF
C <sub>OUT</sub> (Note 14)	Output capacitance (SO)	V <sub>OUT</sub> = 0V	8	pF
C <sub>IN</sub> ( <u>Note 14</u> )	Input capacitance (A0, A1, $\overline{\text{CS}}$ , $\overline{\text{WP}}$ , $\overline{\text{HOLD}}$ , and SCK)	V <sub>IN</sub> = 0V	6	pF

# **Power-Up Timing**

SYMBOL	PARAMETER	MIN	MAX	UNITS
t <sub>r</sub> V <sub>CC</sub> (Note 14)	V <sub>CC</sub> Power-up Rate	0.2		V/ms
t <sub>PUR</sub> (Note 15)	Power-up to Initiation of Read Operation		1	ms
t <sub>PUW</sub> (Note 15)	Power-up to Initiation of Write Operation		50	ms

### **AC Test Conditions**

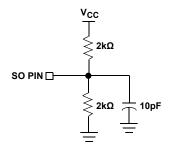
Input Pulse Levels	V <sub>CC</sub> x 0.1 to V <sub>CC</sub> x 0.9
Input Rise and Fall Times	10ns
Input and Output Timing Level	V <sub>CC</sub> x 0.5

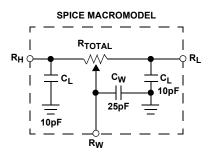
#### NOTES:

- 9. Absolute linearity is utilized to determine actual wiper voltage versus expected voltage as determined by wiper position when used as a potentiometer.
- 10. Relative linearity is utilized to determine the actual change in voltage between two successive tap positions when used as a potentiometer. It is a measure of the error in step size.
- 11. MI = RTOT/255 or  $(R_H R_L)/255$ , single pot.
- 12. During power up  $V_{CC} > V_H$ ,  $V_L$ , and  $V_W$ .
- 13. n = 0, 1, 2, ..., 255; m = 0, 1, 2, ..., 254.
- 14. This parameter is not 100% tested
- 15. tpuR and tpuW are the delays required from the time the (last) power supply (V<sub>CC</sub>-) is stable until the specific instruction can be issued. These parameters are periodically sampled and not 100% tested.

RENESAS

# **Equivalent AC Load Circuit**





# **AC TIMING**

SYMBOL	PARAMETER	MIN	MAX	UNITS	
fsck	SPI clock frequency		2	MHz	
tcyc	SPI Clock Cycle Time	500	500 ns		
t <sub>WH</sub>	SPI Clock High Time 200			ns	
t <sub>WL</sub>	SPI Clock Low Time	200		ns	
t <sub>LEAD</sub>	Lead Time	250		ns	
t <sub>LAG</sub>	Lag Time	250		ns	
t <sub>SU</sub>	SI, SCK, HOLD and CS Input Setup Time	50		ns	
t <sub>H</sub>	SI, SCK, HOLD and CS Input Hold Time	50		ns	
t <sub>RI</sub>	SI, SCK, HOLD and CS Input Rise Time		2	μs	
t <sub>Fl</sub>	SI, SCK, HOLD and CS Input Fall Time		2	μs	
t <sub>DIS</sub>	SO Output Disable Time	0	250	ns	
t <sub>V</sub>	SO Output Valid Time		200	ns	
t <sub>HO</sub>	SO Output Hold Time	0		ns	
t <sub>RO</sub> (Note 14)	SO Output Rise Time		100	ns	
t <sub>FO</sub> ( <u>Note 14</u> )	SO Output Fall Time		100	ns	
tHOLD	HOLD Time	400		ns	
t <sub>HSU</sub>	HOLD Setup Time	100		ns	
t <sub>HH</sub>	HOLD Hold Time	100		ns	
t <sub>HZ</sub>	HOLD Low to Output in High Z		100	ns	
t <sub>LZ</sub>	HOLD High to Output in Low Z		100	ns	
TĮ	Noise Suppression Time Constant at SI, SCK, HOLD and CS Inputs		10	ns	
t <sub>CS</sub>	CS Deselect Time	2		μs	
twpasu	WP, AO Setup Time	0		ns	
t <sub>WPAH</sub>	WP, AO Hold Time	0		ns	

# **High-Voltage Write Cycle Timing**

SYMBOL	PARAMETER	TYP	MAX	UNITS
t <sub>WR</sub>	High-voltage write cycle time (store instructions)	5	10	ms

# **XDCP Timing**

SYMBOL	PARAMETER	MIN	MAX	UNITS
t <sub>WRPO</sub> (Note 14	Wiper response time after the third (last) power supply is stable	5	10	μs
t <sub>WRL</sub> (Note 14	Wiper response time after instruction issued (all load instructions)	5	10	μs

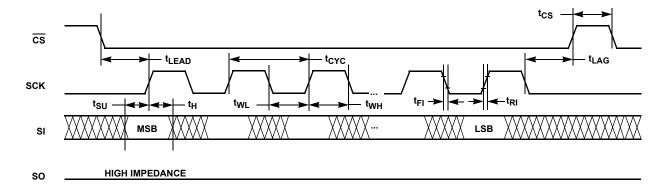


# **Symbol Table**

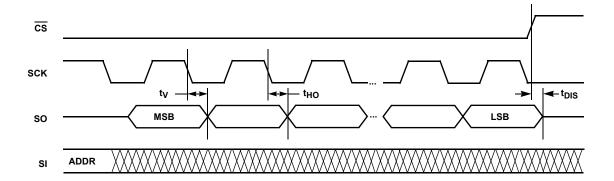
INPUTS	OUTPUTS
Must be steady	Will be steady
May change from Low to High	Will change from Low to High
May change from High to Low	Will change from High to Low
Don't Care: Changes Allowed	Changing: State Not Known
N/A	Center Line is High Impedance
	Must be steady  May change from Low to High  May change from High to Low  Don't Care: Changes Allowed

# **Timing Diagrams**

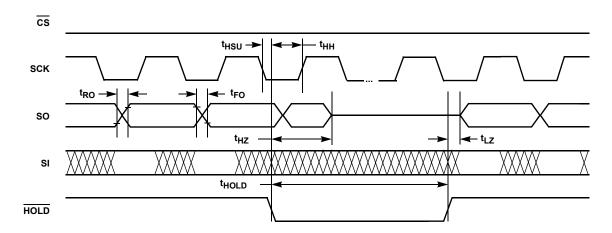
# **Input Timing**



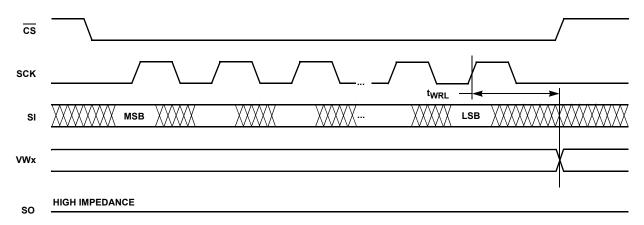
# **Output Timing**



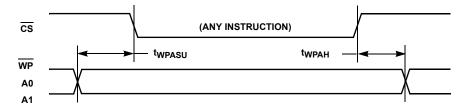
# **Hold Timing**



# **XDCP Timing (for All Load Instructions)**

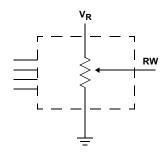


# **Write Protect and Device Address Pins Timing**

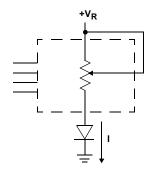


# **Applications information**

# **Basic Configurations of Electronic Potentiometers**



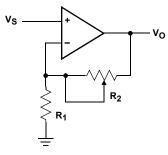
Three terminal Potentiometer; Variable voltage divider



Two terminal Variable Resistor; Variable current

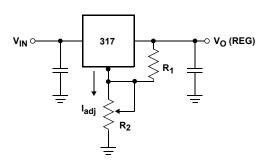
# **Application Circuits**

#### **NON INVERTING AMPLIFIER**



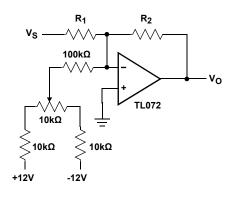
 $V_0 = (1 + R_2/R_1)V_S$ 

#### **VOLTAGE REGULATOR**

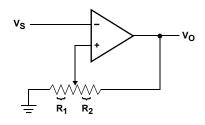


 $V_0$  (REG) = 1.25V (1 +  $R_2/R_1$ ) +  $I_{adj}$   $R_2$ 

#### **OFFSET VOLTAGE ADJUSTMENT**



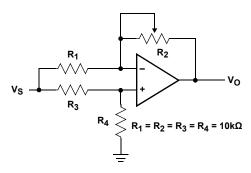
#### **COMPARATOR WITH HYSTERESIS**



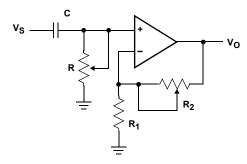
 $V_{UL} = \{R_1/(R_1 + R_2)\} V_0(max)$  $RL_L = \{R_1/(R_1 + R_2)\} V_0(min)$ 

# **Application Circuits (continued)**

#### **ATTENUATOR**



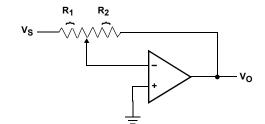
$$V_0 = G V_S$$
  
-1/2  $\leq G \leq$  +1/2



**FILTER** 

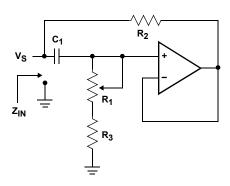
 $G_0 = 1 + R_2/R_1$  $fc = 1/(2\pi RC)$ 

#### **INVERTING AMPLIFIER**



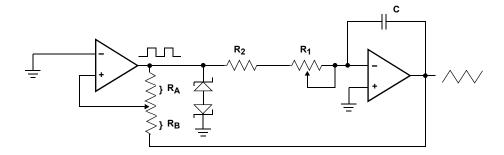
 $V_0 = G V_S$  $G = -R_2/R_1$ 

#### **EQUIVALENT L-R CIRCUIT**



 $Z_{IN} = R_2 + s R_2 (R_1 + R_3) C_1 = R_2 + s Leq$   $(R_1 + R_3) >> R_2$ 

#### **FUNCTION GENERATOR**



 $\textbf{FREQUENCY} \propto \textbf{R_1}, \textbf{R_2}, \textbf{C}$  $\textbf{AMPLITUDE} \propto \textbf{R}_{\textbf{A}}, \textbf{R}_{\textbf{B}}$ 

# **Revision History**

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please go to the web to make sure that you have the latest revision.

DATE	REVISION	CHANGE
December 3, 2014	FN8166.6	Updated to Intersil new standards.  Updated Ordering Information Table on page 3, by removing obsoleted parts and 100kΩ referenced parts, adding Note 3 and changed TSSOP POD references from "MDP0044" to "M24.173".  Added Revision History and About Intersil verbiage.  Updated M24.3 POD to the latest revision.  -"Updated to new POD standard by removing table listing dimensions and putting dimensions on drawing.  Added Land Pattern."  Replaced MDP0044 POD with M24.173 POD to update to new format and only show 24 Ld version.

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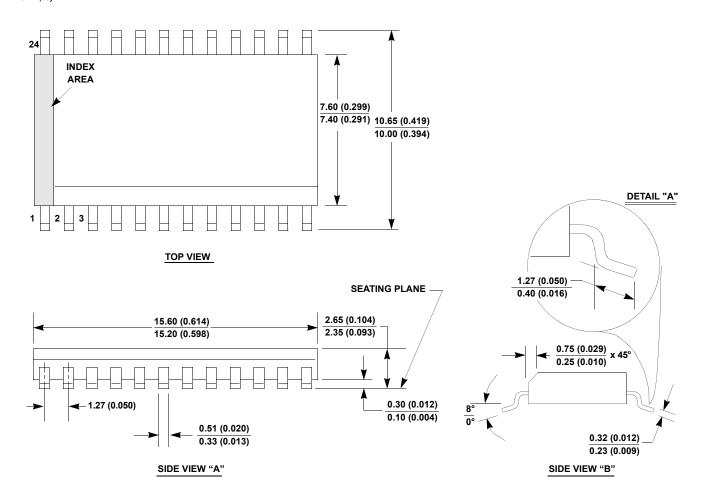
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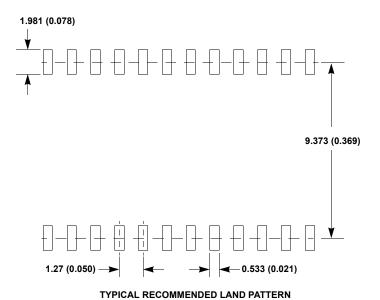


# **Package Outline Drawing**

#### M24.3

24 LEAD WIDE BODY SMALL OUTLINE PLASTIC PACKAGE (SOIC) Rev 2, 3/11





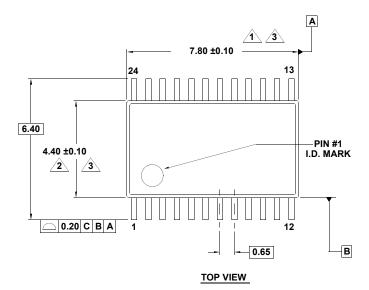
#### NOTES:

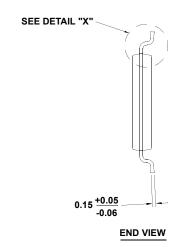
- 1. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Package length does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- 3. Package width does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
- 4. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- 5. Terminal numbers are shown for reference only.
- The lead width as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch).
- 7. Controlling dimension: MILLIMETER. Converted inch dimensions in ( ) are not necessarily exact.
- 8. This outline conforms to JEDEC publication MS-013-AD ISSUE C.

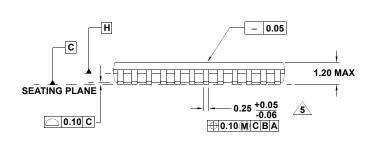
# **Package Outline Drawing**

### M24.173

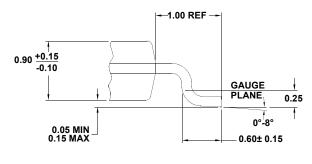
24 LEAD THIN SHRINK SMALL OUTLINE PACKAGE (TSSOP) Rev 1, 5/10

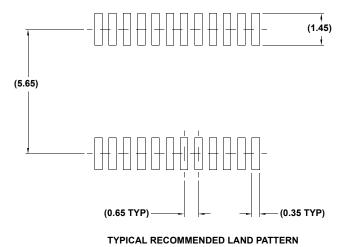






SIDE VIEW





#### NOTES:

1. Dimension does not include mold flash, protrusions or gate burrs.

Mold flash, protrusions or gate burrs shall not exceed 0.15 per side.

**DETAIL "X"** 

- 2. Dimension does not include interlead flash or protrusion. Interlead flash or protrusion shall not exceed 0.25 per side.
- 3. Dimensions are measured at datum plane H.
- 4. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 5. Dimension does not include dambar protrusion. Allowable protrusion shall be 0.08mm total in excess of dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07mm.
- 6. Dimension in ( ) are for reference only.
- 7. Conforms to JEDEC MO-153.

# **ПОСТАВКА** ЭЛЕКТРОННЫХ КОМПОНЕНТОВ

Общество с ограниченной ответственностью «МосЧип» ИНН 7719860671 / КПП 771901001 Адрес: 105318, г.Москва, ул.Щербаковская д.3, офис 1107

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